

## **Sup/IRBuck™**

### **USER GUIDE FOR IR3842A EVALUATION BOARD**

#### **Double Sided PCB**

#### **DESCRIPTION**

The IR3842A is a synchronous buck converter, providing a compact, high performance and flexible solution in a small 5mmx6mm Power QFN package.

Key features offered by the IR3842A include programmable soft-start ramp, precision 0.7V reference voltage, Power Good, thermal protection, programmable switching frequency, Sequence input, Enable input, input under-voltage lockout for proper start-up, and pre-bias start-up.

An output over-current protection function is implemented by sensing the voltage developed across the on-resistance of the synchronous rectifier MOSFET for optimum cost and performance.

This user guide contains the schematic and bill of materials for the IR3842A evaluation board. The guide describes operation and use of the evaluation board itself. Detailed application information for IR3842A is available in the IR3842A data sheet.

---

#### **BOARD FEATURES**

- $V_{in} = +12V$  (13.2V Max)
- $V_{cc} = +5V$  (5.5V Max)
- $V_{out} = +1.8V @ 0- 6A$
- $F_s = 600kHz$
- $L = 1.0uH$
- $C_{in} = 2x10uF$  (ceramic 1206)
- $C_{out} = 4x22uF$  (ceramic 0805)

## CONNECTIONS and OPERATING INSTRUCTIONS

A well regulated +12V input supply should be connected to VIN+ and VIN-. A maximum 6A load should be connected to VOUT+ and VOUT-. The connection diagram is shown in Fig. 1 and inputs and outputs of the board are listed in Table I.

IR3842A has two input supplies, one for biasing (Vcc) and the other as input voltage (Vin). Separate supplies should be applied to these inputs. Vcc input should be a well regulated 4.5V-5.5V supply and it would be connected to Vcc+ and Vcc-.

**Table I. Connections**

Connection	Signal Name
VIN+	$V_{in}$ (+12V)
VIN-	Ground of $V_{in}$
Vcc+	Vcc input
Vcc-	Ground for Vcc input
VOUT-	Ground of $V_{out}$
VOUT+	$V_{out}$ (+1.8V)
Enable	Enable
Seq.	Sequence Input
PGood	Power Good Signal

## LAYOUT

The PCB is a 4-layer board. All of layers are 2 Oz. copper. It is a double sided board with components mounted on both sides.

Power supply decoupling capacitors, the Bootstrap capacitor and feedback components are located close to IR3842A. The feedback resistors are connected to the output voltage at the point of regulation and are located close to the SupIRBuck. To improve efficiency, the circuit board is designed to minimize the length of the on-board power ground current path.

Connection Diagram

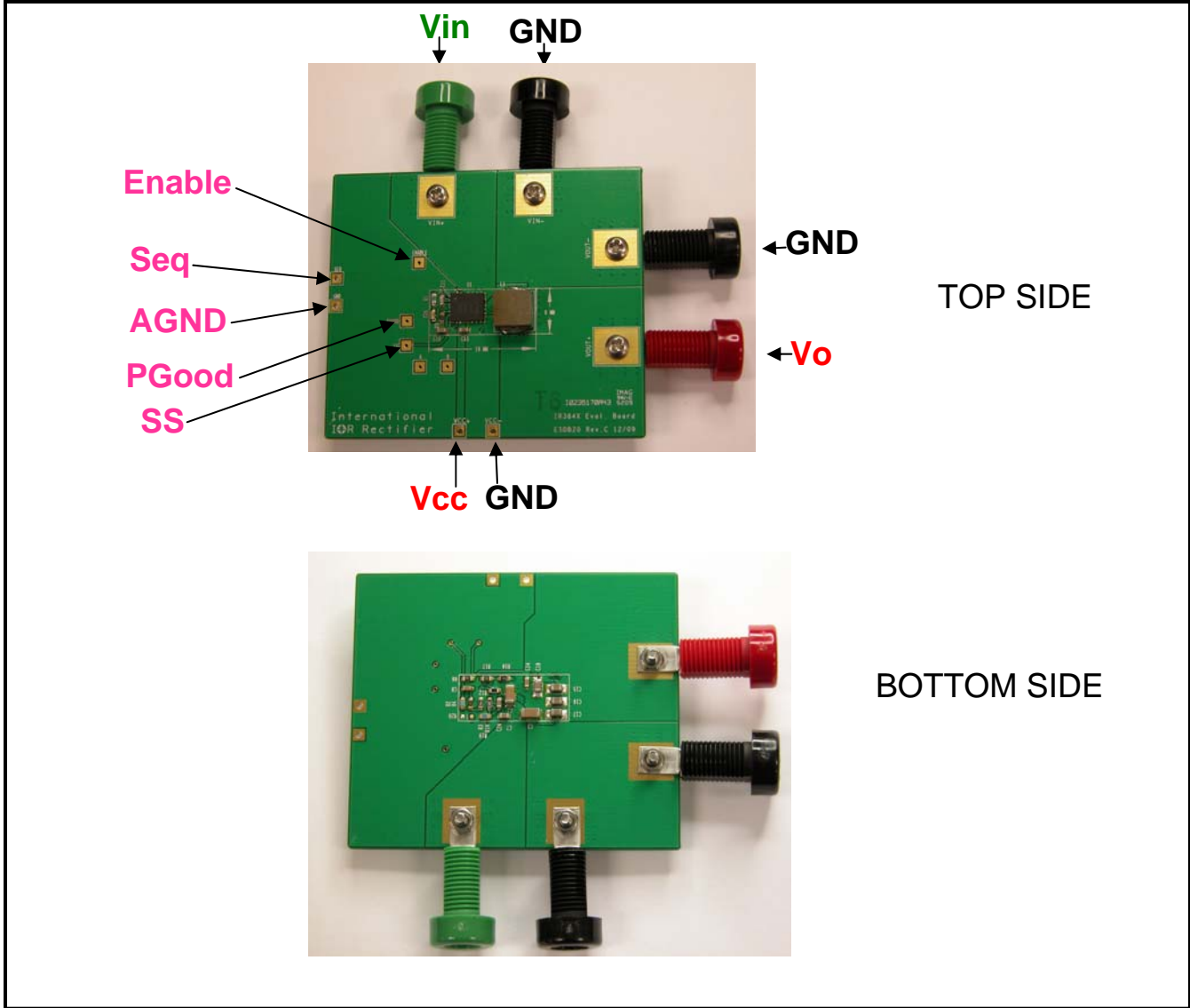


Fig. 1: Connection diagram of IR384xA evaluation board

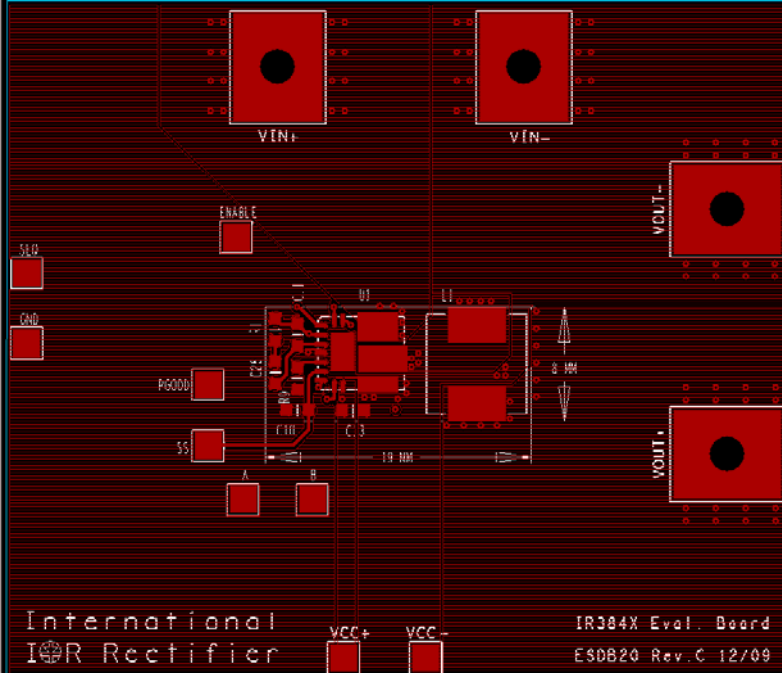


Fig. 2: Board layout, top overlay

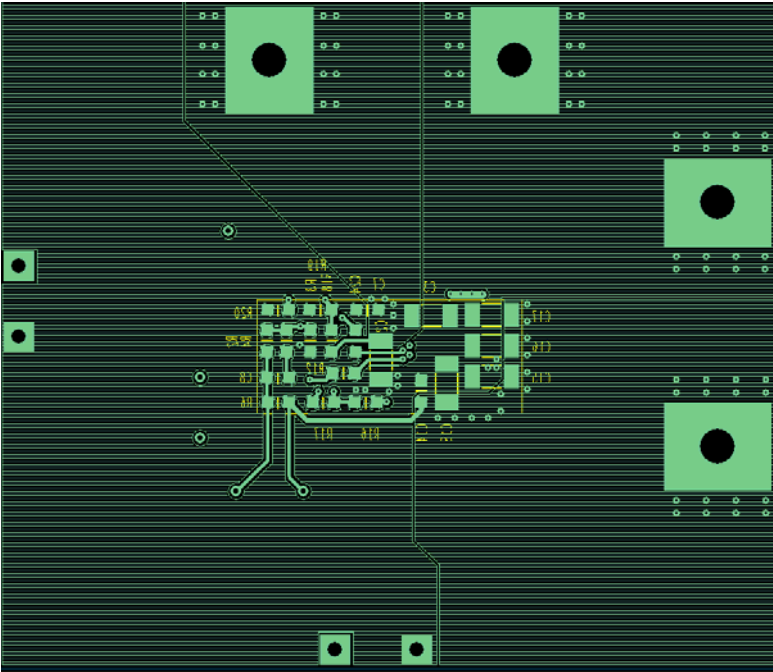
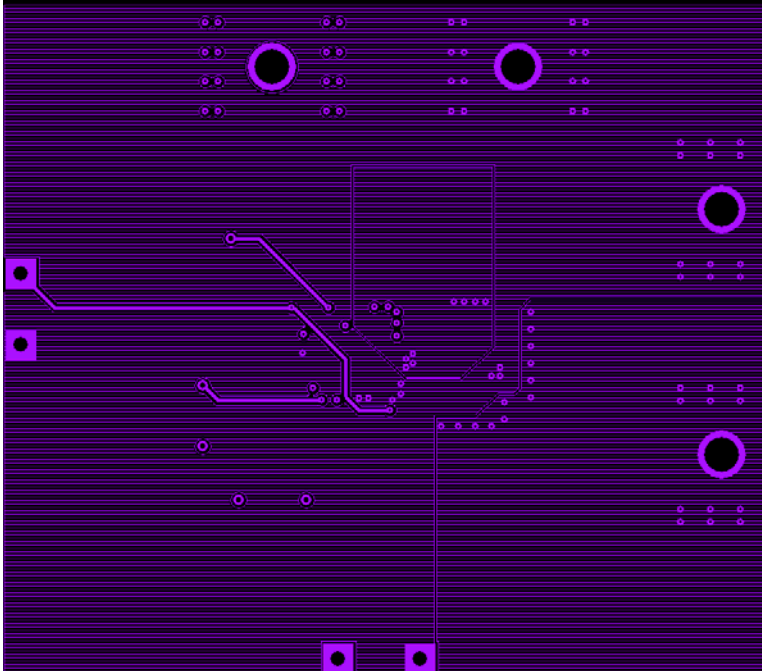


Fig. 3: Board layout, bottom overlay (rear view)



**Fig. 4: Board layout, mid-layer I.**



**Fig. 5: Board layout, mid-layer II.**



Bill of Materials

Item	Quantity	Part Reference	Value	Description	Manufacturer	Part Number
1	2	C2 ,C3	10uF	10uF,1206,16V, X7R, 20%	Panasonic - ECG	ECJ-3YX1C106K
2	4	C7 C14 C24 C10	0.1uF	0603, 25V, X7R, 10%	Panasonic	ECJ-1VB1E104K
3	1	C8	2200pF	0603,50V,X7R, 10%	Panasonic	ECJ-1VB1H222K
4	1	C11	270pF	50V, 0603, NP0, 5%	Murata	GRM1885C1H271JA01D
5	1	C13	1uF	16V, 0603, X5R, 10%	Murata	GRM188R61C105KA93B
6	4	C15 C16 C17 C18	22uF	0805, 6.3V, X5R, 20%	Panasonic	ECJ-2FB0J226M
7	1	C26	10nF	0603, 50V, X7R, 10%	Panasonic	ECJ-1VB1H103K
8	1	L1	1.0uH	6.86*6.47*5.0mm	Vishay/Dale	IHLP2525EZER1R0M01
9	1	R1	2.0k	0603,1/10W,1%	Rohm	MCR03EZPFX2001
10	1	R2	4.99k	0603,1/10W,1%	Rohm	MCR03EZPFX4991
11	1	R3	3.16k	0603,1/10W,1%	Rohm	MCR03EZPFX3161
12	1	R4	130	0603,1/10W,1%	Panasonic	ERJ-3EKF1300V
13	1	R6	20	0603,1/10 W,1%	Vishay/Dale	CRCW060320R0FKEA
14	1	R9	23.7K	0603,1/10W,1%	Rohm	MCR03EZPFX2372
15	1	R16	0	0603,1/10 W,5%	Vishay/Dale	CRCW06030000Z0EA
16	1	R12	2.67K	0603,1/10 W,1%	Rohm	MCR03EZPFX2671
17	1	R17	10K	0603,1/10 W,1%	Rohm	MCR03EZPFX1002
18	1	R18	49.9k	0603,1/10 W,1%	Rohm	MCR03EZPFX4992
19	1	R19	7.5k	0603,1/10W,1%	Rohm	MCR03EZPFX7501
20		R20	Not used			
21	1	U1	IR3842A	6A SupIRBuck, PQFN 5x6mm	International Rectifier	IR3842AMPbF

## TYPICAL OPERATING WAVEFORMS

$V_{in}=12.0V$ ,  $V_{cc}=5V$ ,  $V_o=1.8V$ ,  $I_o=0-6A$ , Room Temperature, No Air Flow

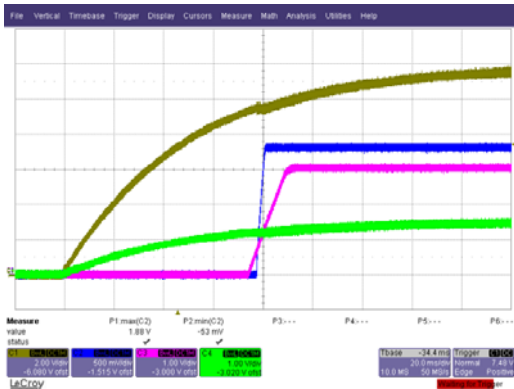


Fig. 7. Start up at 6A Load  
Ch<sub>1</sub>:V<sub>in</sub>, Ch<sub>2</sub>:V<sub>o</sub>, Ch<sub>3</sub>:V<sub>ss</sub>, Ch<sub>4</sub>:Enable

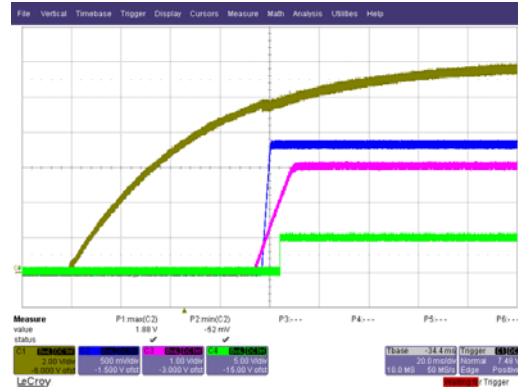


Fig. 8. Start up at 6A Load,  
Ch<sub>1</sub>:V<sub>in</sub>, Ch<sub>2</sub>:V<sub>o</sub>, Ch<sub>3</sub>:V<sub>ss</sub>, Ch<sub>4</sub>:V<sub>PGood</sub>

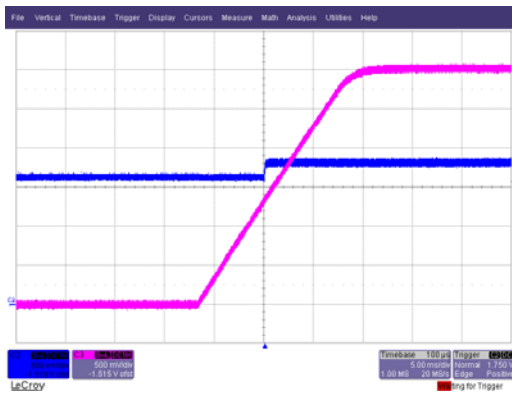


Fig. 9. Start up with 1.62V Pre Bias, 0A Load, Ch<sub>2</sub>:V<sub>o</sub>, Ch<sub>3</sub>:V<sub>ss</sub>

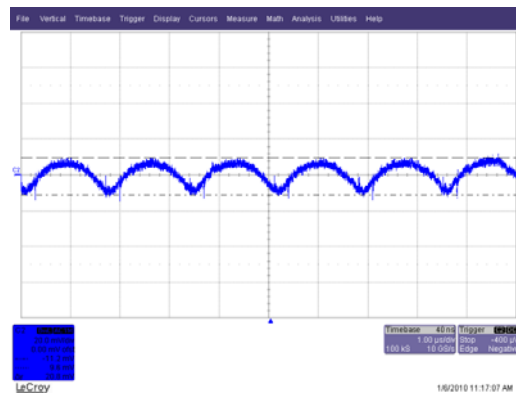


Fig. 10. Output Voltage Ripple, 6A load  
Ch<sub>2</sub>:V<sub>o</sub>

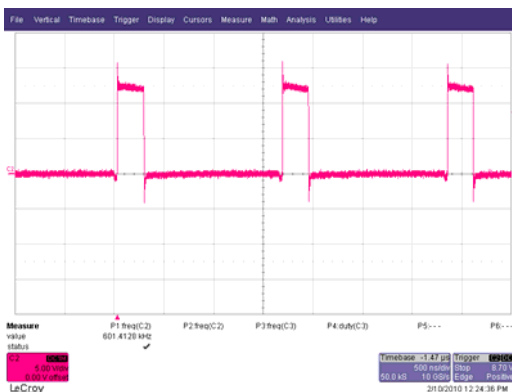


Fig. 11. Inductor node at 6A load  
Ch<sub>1</sub>:LX

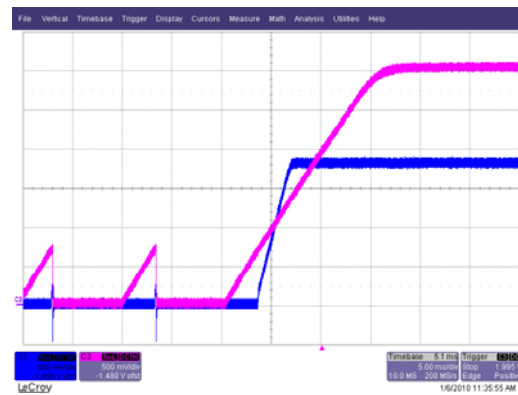


Fig. 12. Short (Hiccup) Recovery  
Ch<sub>2</sub>:V<sub>o</sub>, Ch<sub>3</sub>:V<sub>ss</sub>



**TYPICAL OPERATING WAVEFORMS**

Vin=12V, Vcc=5V, Vo=1.8V, Io=0-6A, Room Temperature, No Air Flow

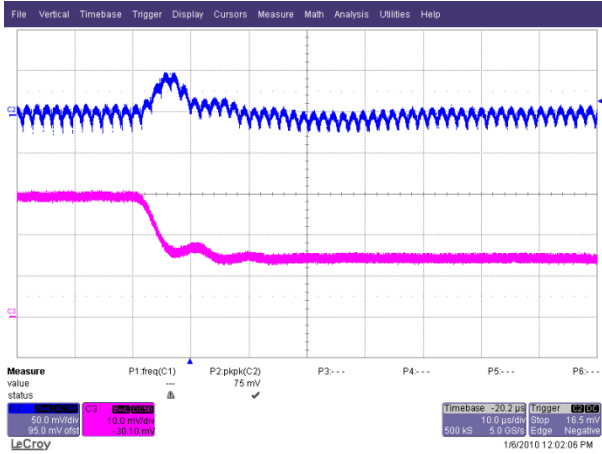
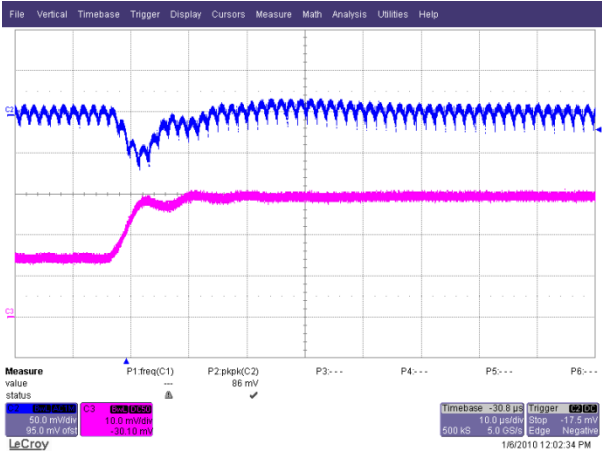
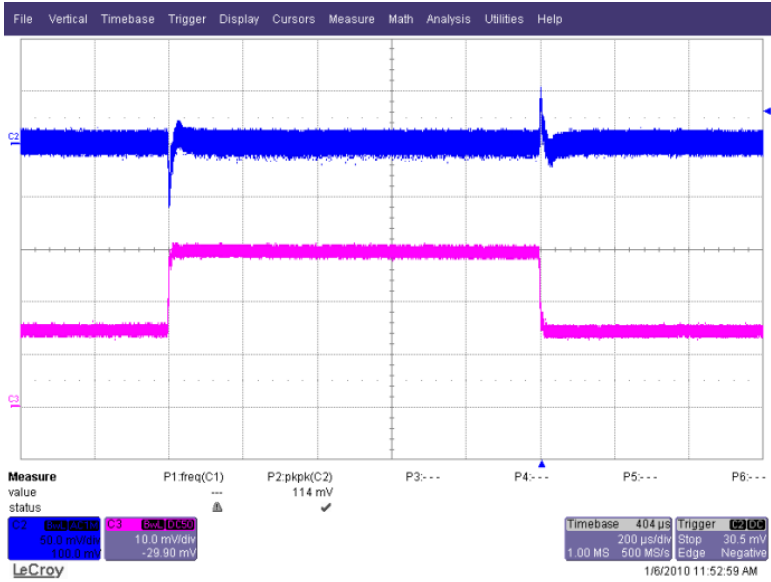


Fig. 13. Transient Response, 3.0A to 6A step 2.5A/μs  
Ch<sub>2</sub>:V<sub>o</sub>; Ch<sub>3</sub>:I<sub>out</sub> (2A/Div)

**TYPICAL OPERATING WAVEFORMS**

Vin=12V, Vcc=5V, Vo=1.8V, Io=6A, Room Temperature, No Air Flow

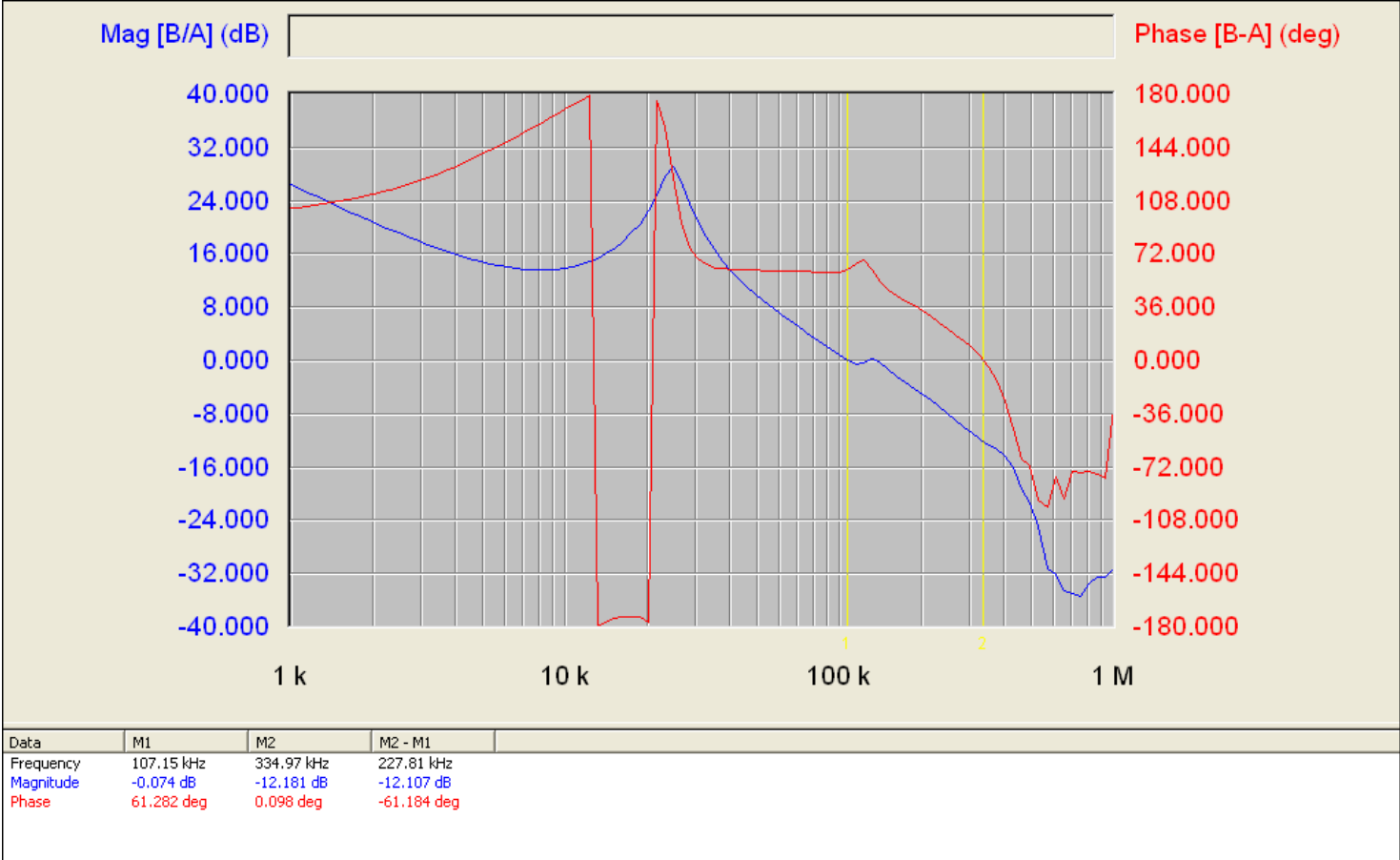


Fig. 14. Bode Plot at 6A load shows a bandwidth of 107.1KHz and phase margin of 61.2°

**TYPICAL OPERATING WAVEFORMS**

Vin=12V, Vcc=5V, Vo=1.8V, Io=0- 6A, Room Temperature, No Air Flow

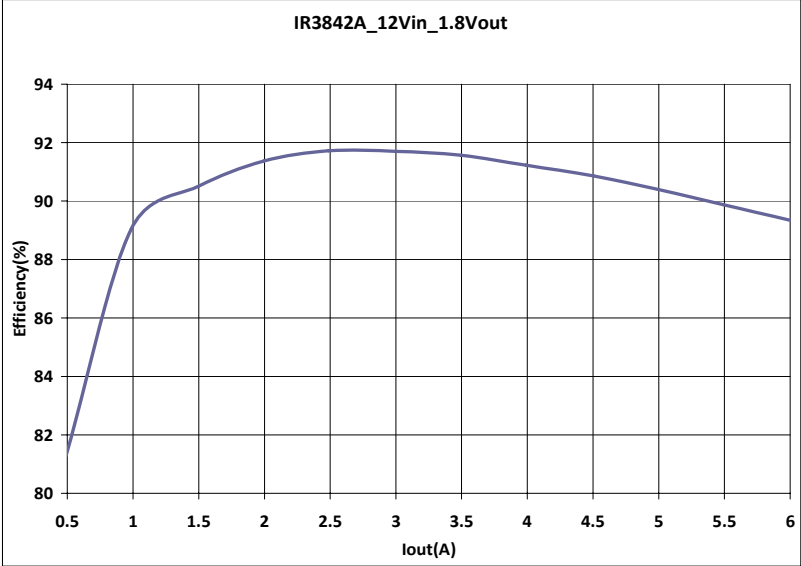


Fig.15: Efficiency versus load current

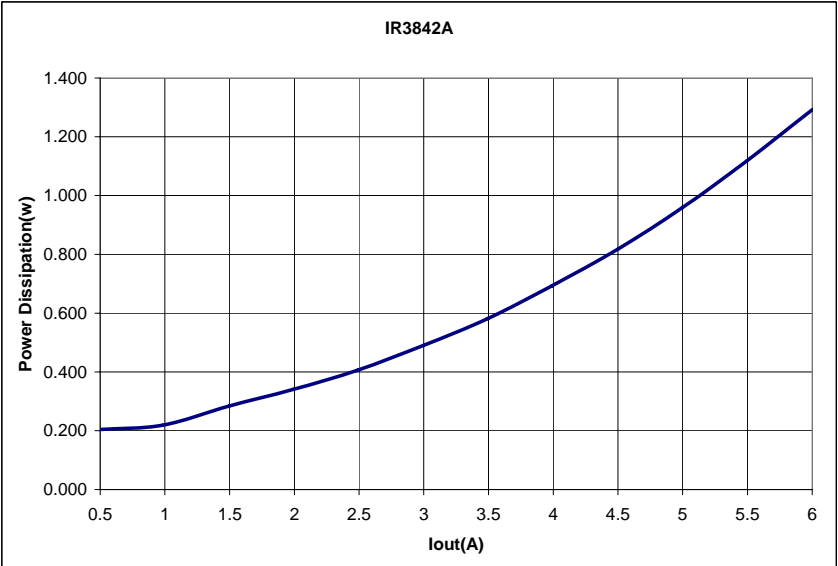


Fig.16: Power loss versus load current

**THERMAL IMAGE**

Vin=12V, Vcc=5V, Vo=1.8V, Io=6A, Room Temperature, No Air Flow

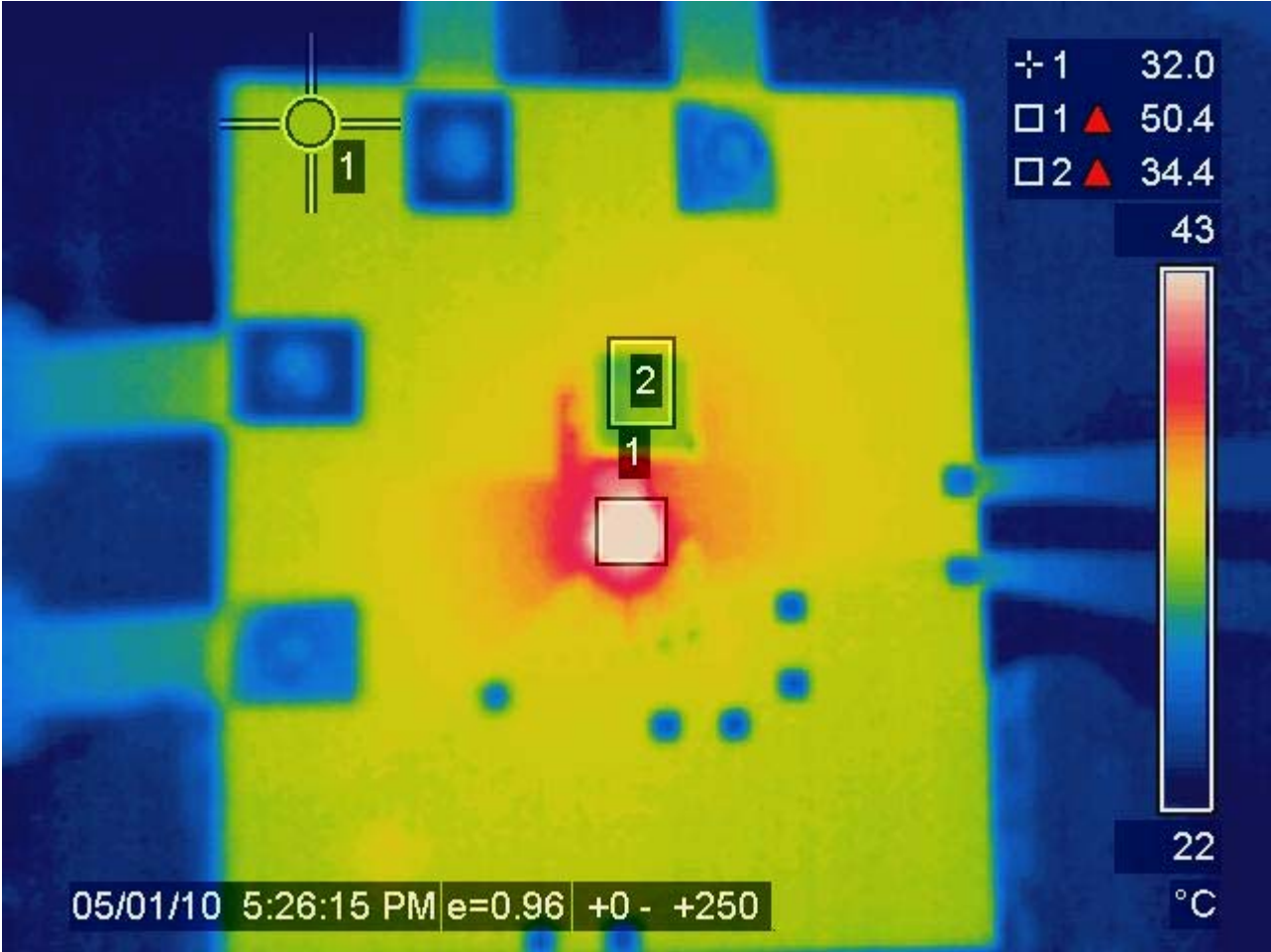


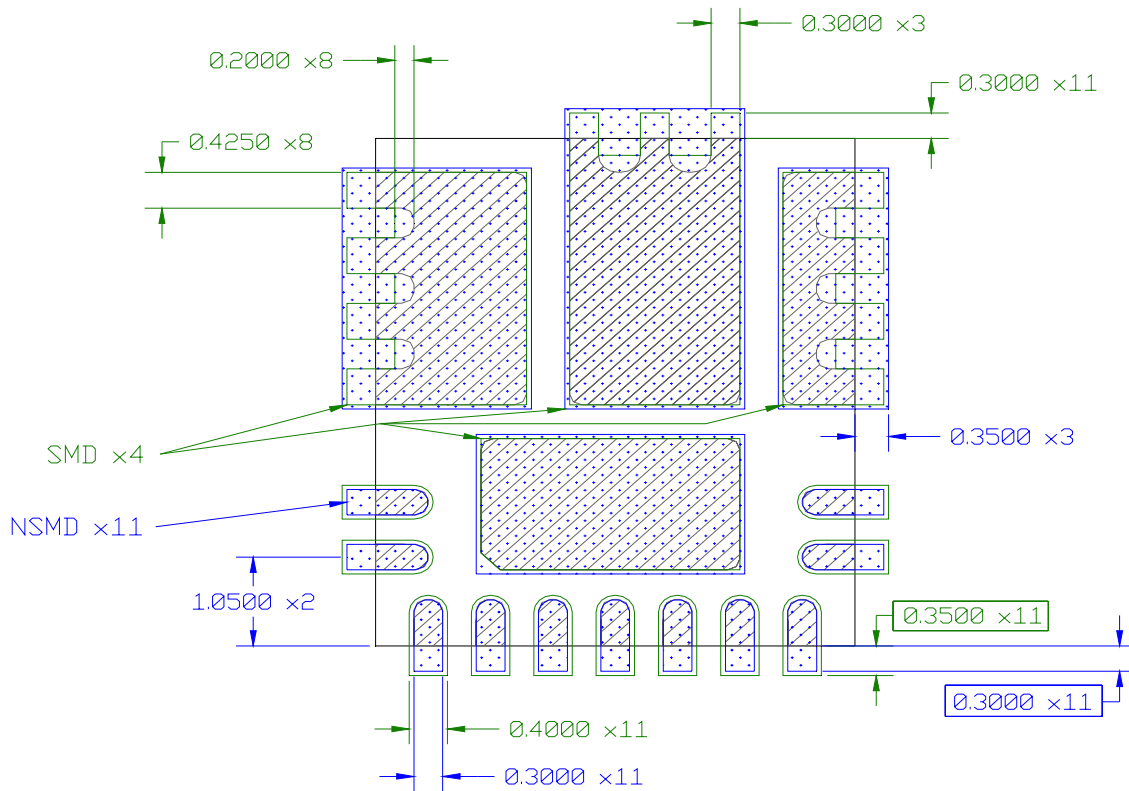
Fig. 17: Thermal Image at 6A load  
Test points 1 and 2 are IR3842A and inductor, respectively.

**PCB Metal and Components Placement**

Lead lands (the 11 IC pins) width should be equal to nominal part lead width. The minimum lead to lead spacing should be  $\geq 0.2\text{mm}$  to minimize shorting.

Lead land length should be equal to maximum part lead length + 0.3 mm outboard extension. The outboard extension ensures a large and inspectable toe fillet.

Pad lands (the 4 big pads other than the 11 IC pins) length and width should be equal to maximum part pad length and width. However, the minimum metal to metal spacing should be no less than 0.17mm for 2 oz. Copper; no less than 0.1mm for 1 oz. Copper and no less than 0.23mm for 3 oz.



All Dimensions in mm

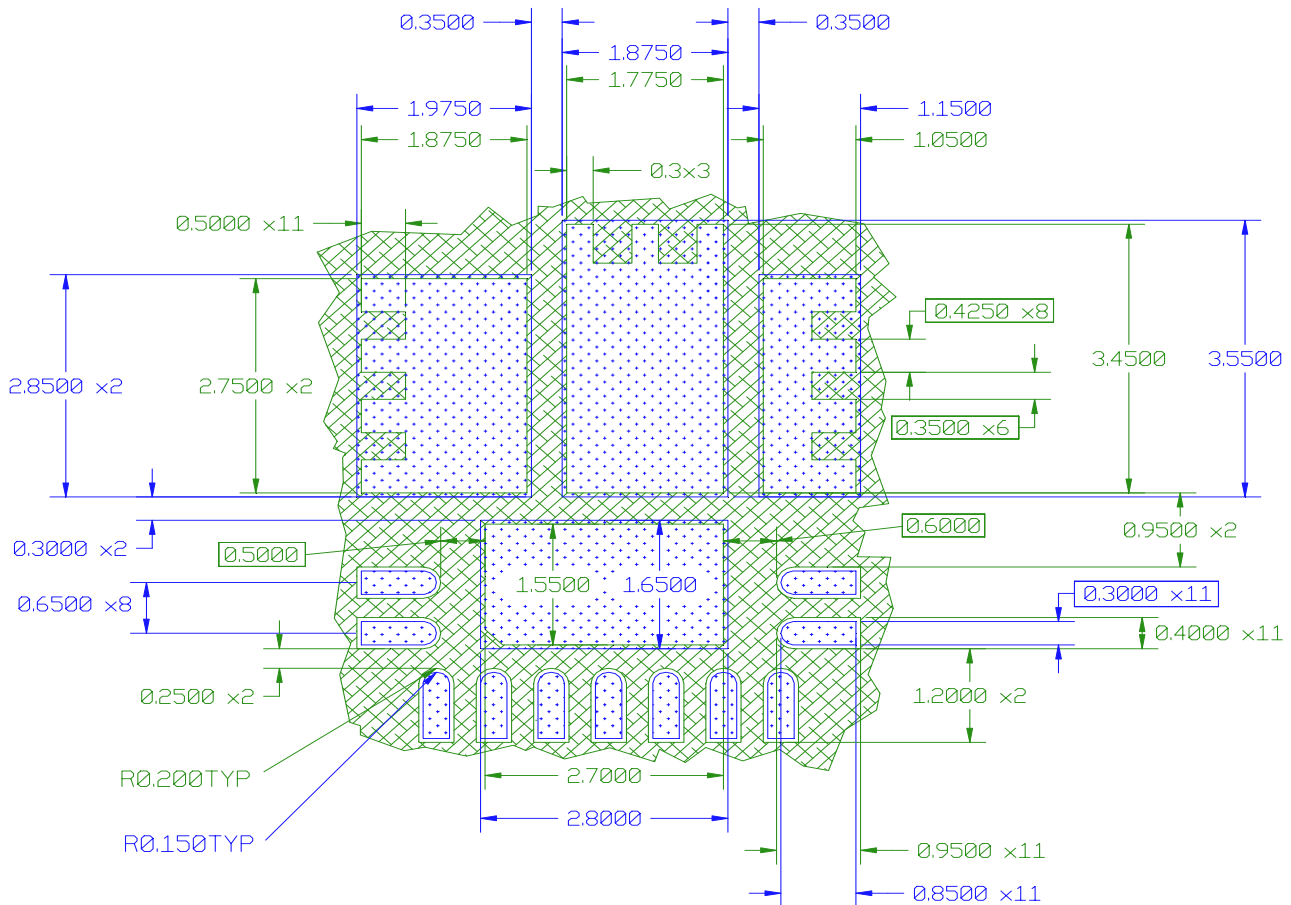


**Solder Resist**

It is recommended that the lead lands are Non Solder Mask Defined (NSMD). The solder resist should be pulled away from the metal lead lands by a minimum of 0.025mm to ensure NSMD pads.



The land pad should be Solder Mask Defined (SMD), with a minimum overlap of the solder resist onto the copper of 0.05mm to accommodate solder resist misalignment.

Ensure that the solder resist in-between the lead lands and the pad land is  $\geq 0.15\text{mm}$  due to the high aspect ratio of the solder resist strip separating the lead lands from the pad land.



All Dimensions in mm

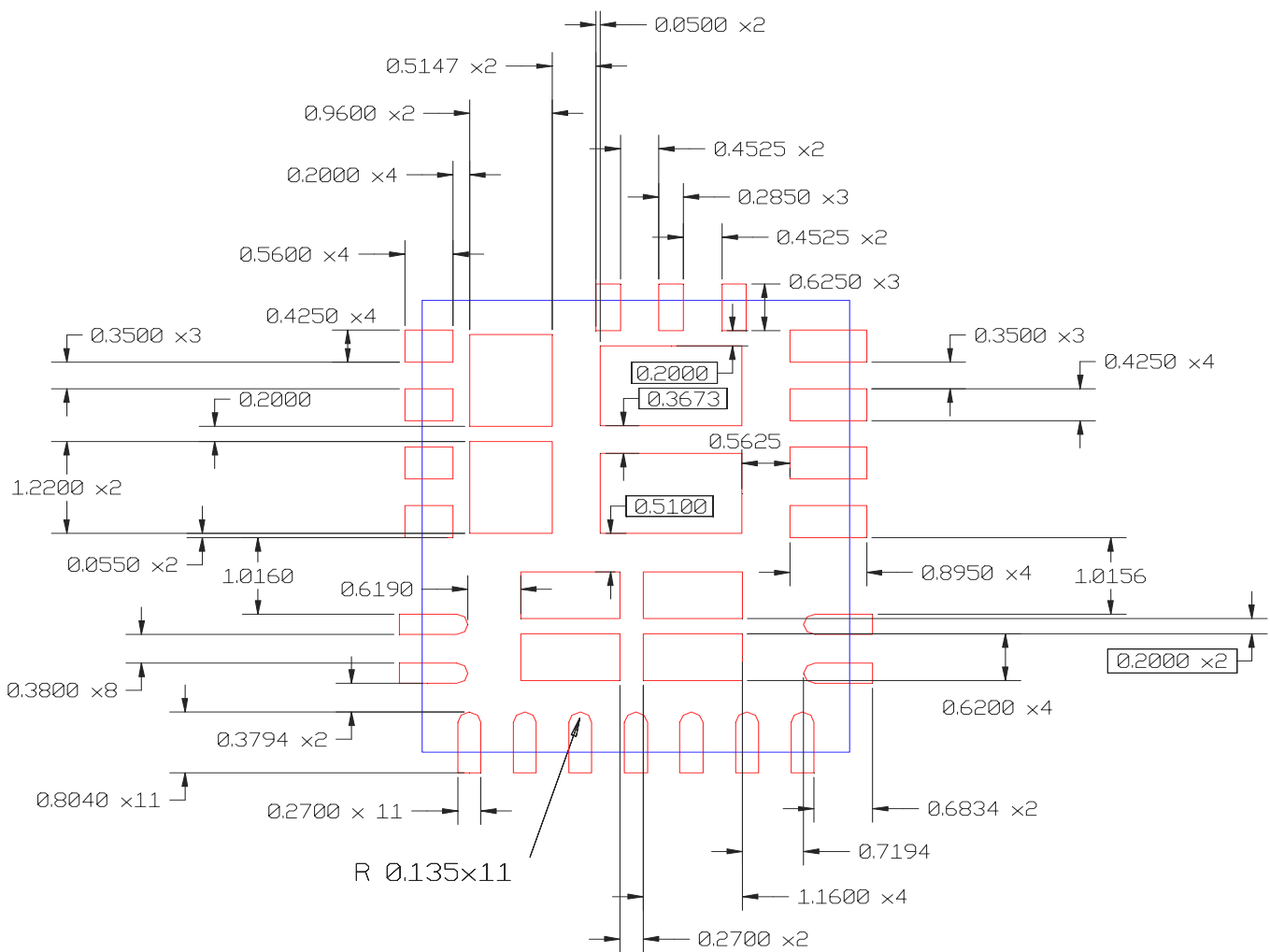
NOTE:

-  PCB Copper
-  PCB Solder Resist

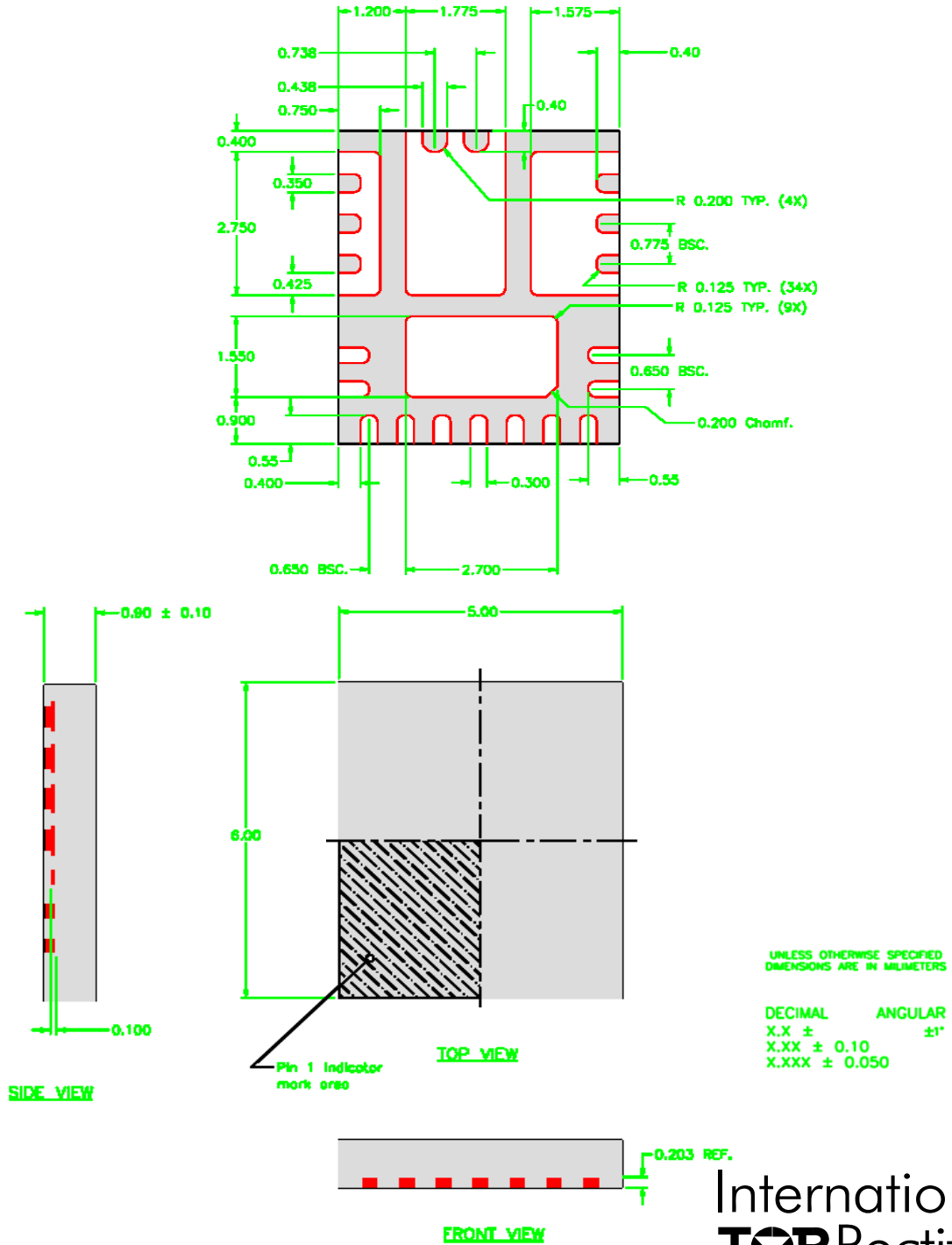
11x Signal Pins are NSMD  
 4x Power Pins are SMD

**Stencil Design**

- The Stencil apertures for the lead lands should be approximately 80% of the area of the lead lads. Reducing the amount of solder deposited will minimize the occurrences of lead shorts. If too much solder is deposited on the center pad the part will float and the lead lands will be open.
- The maximum length and width of the land pad stencil aperture should be equal to the solder resist opening minus an annular 0.2mm pull back to decrease the incidence of shorting the center land to the lead lands when the part is pushed into the solder paste.



Stencil Aperture  
 All Dimensions in mm



**IR WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, USA Tel: (320) 252-7105

TAC Fax: (320) 252-7903

**This product has been designed and qualified for the Consumer market**

Visit us at [www.irf.com](http://www.irf.com) for sales contact information

*Data and specifications subject to change without notice. 01/10*